Docket No.

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HI-0172

## DECLARATION AND POWER OF ATTORNEY

sted below) of the subject	tret and sole inventor (ir only t matter claimed and for which STOGRAM, the specification	y one name is listed below) or an original, f th a patent is sought on the invention entit a of which	ed METHOD OF QUANTIZING BIN
X ] is attached hereto	[] was filed on	as Application Serial No (if applicable)	್ಷಾ ಕ್ಷಾ ಕ್ಷಾ ಕ್ಷಾ ಕ್ಷಾ ಕ್ಷಾ ಕ್ಷಾ ಕ್ಷಾ ಕ
hereby state that I have numendment referred to ab	eviewed and understand the c	contents of the above identified specification	n, including the claims, as amended by any
Rekassledge the duty to Federal Regulations, Secti	o disclose information which on 1.56(a).	is known to me to be material to patental	rility in accordance with Title 37, Code of
or 365(a) of my PCT inte and have also identified b application having a filing	mational application which of clow, by checking the box, as date before that of the appli	. 119(a)-(d) or 365 (b) of any foreign applied designated at least one country other than any foreign application for parent or inventor cation on which priority is claimed.	the United States of America, listed below or's certificate, or of any PCT internations
Prior Foreign Applicati Nurober	on(s): <u>Countr</u>	Foreign Filing Da Month/Day/Year	
4610 <u>89/2002</u>	Korea	October 7, 2002	_
<u> </u>			
Thereby claim the beach Application Number(s	•	ny United States provisional application(s)  Filing Date (Month/Day/Year)	listed below.
I hereby claim the benefit Application Number(s)  I hereby claim the benefit the United States of Amorphor United States or PC to disclose information w	tunder 35 U.S.C. 120 of any Ucrica, listed below and, insofa	Filing Date (Month/Dav/Year) United States application(s), or 365(c) of an area the subject matter of each of the claim the manner provided by the first paragrap by as defined in 37 CFR 1.56 which became	y PCT international application designations of this application is not disclosed in the of 35 U.S.C. 112, I acknowledge the du
I hereby claim the benefit Application Number(s)  I hereby claim the benefit the United States of Amorphor United States or PC to disclose information w	t under 35 U.S.C. 120 of any U.S.C. 120 of any U.S.C. 120 of any U.S.C. 120 of any U.S.C. listed below and, insofa T international application in thich is material to patentabilities of the patentabilities	Filing Date (Month/Dav/Year) United States application(s), or 365(c) of an area the subject matter of each of the claim the manner provided by the first paragrap by as defined in 37 CFR 1.56 which became	y PCT international application designations of this application is not disclosed in the of 35 U.S.C. 112, I acknowledge the du

Thereby appoint the following strongey (s) and/or agent (s) Daniel Y.J. Kim, Registration No. 36,186; Mark L. Fleshner, Registration No. 34,596; Carl R. Wesolowski, Registration No. 40,372; John C. Eisenhart, Registration No. 38,128; Donald R. McPhail, Registration No. 35,811; Renc A. Vazquez, Registration No. 38,647; Carol L. Druzbick, Registration No. 40,287; Anthony H. Nourse, Registration No. 46,121; Laura L. Die, Registration No. 48,752; Timothy M. Speer, Registration No. 47,355; Samuel W. Ntiros, Registration No. 39,318; Mark R. Buscher, Registration No. 35,006; Daniel H. Sherz, Registration No. 46,425; John L. Ciccozzi, Registration No. 48,984; Steven J. Helmer, Registration No. 40,475; and Mark E. Olds, Registration No. 46,507, all of

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with full power of substitution and revocation, to proscente this application and to transact all business in the Patent and Trademark Office connected therewith, and all future comespondence should be addressed to them.

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